

4 CHANNEL LOW CAPACITANCE BI-DIRECTIONAL TVS ARRAY

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±30kV
- 4 Channels of Bi-directional ESD Protection
- Low Channel Input Capacitance
- Typically Used at Portable Electronics, Cellular Handsets and Communication Systems
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

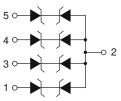
Mechanical Data

- Case: SOT353
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.006 grams (approximate)

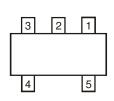
SOT353





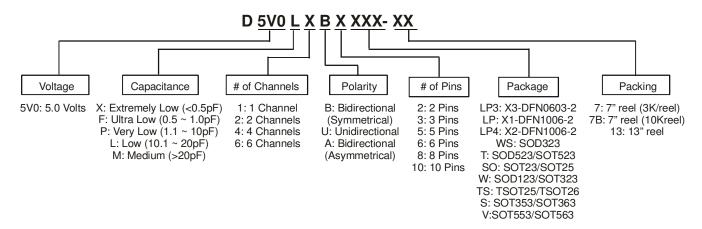


Device Schematic



Top View Pin Configuration

Ordering Information (Note 3)



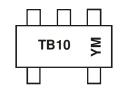
Part Number	Case	Packaging
D5V0L4B5S-7	SOT353	3000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



TB10 = Product Type Marking Code

YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Date Code Noy												
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Υ		Z		Α		В	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	84	W	8/20μs, Per Fig. 2
Peak Pulse Current	I _{PP}	6	Α	8/20μs, Per Fig. 2
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	$V_{ESD\ Air}$	±30	kV	Standard IEC 61000-4-2

Thermal Characteristics

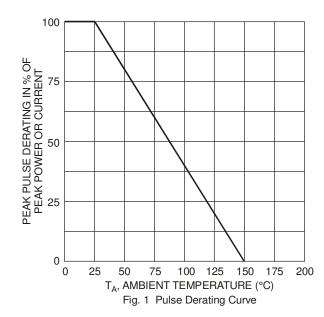
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	625	°C/W
Operating Junction Temperature Range	TJ	-65 to +150	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

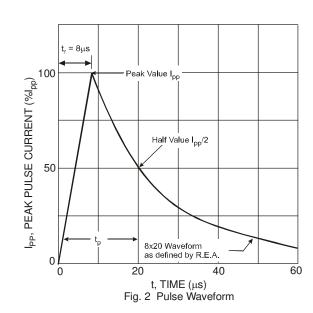
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	-	-	5.0	V	-
Breakdown Voltage	V_{BR}	6	7	8	V	I _R = 1.0mA
Reverse Leakage Current (Note 6)	I _R	-	10	100	nA	V _{RWM} = 5V
Clamping Voltage (Note 4)		-	7.0	9.0	V	$I_{PP} = 1A, t_p = 8/20 \mu S$
	Voi	-	8.7	10.7	V	$I_{PP} = 3A, t_p = 8/20\mu S$
	VcL	-	10.5	12.0	V	$I_{PP} = 5A, t_p = 8/20\mu S$
		-	11.5	14.0	V	$I_{PP} = 6A, t_p = 8/20\mu S$
Differential Resistance	R _{DIF}	-	0.2	-	Ω	$I_R = 1.0A, t_p = 8/20\mu S$
Channel Input Capacitance	Ст	-	15	20	pF	V _{IN} = 0 V, f = 1MHz (Channel to Pin 2)

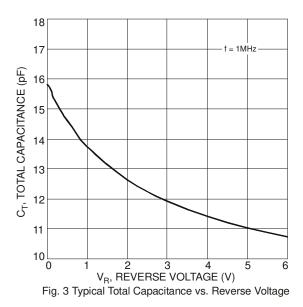
Notes:

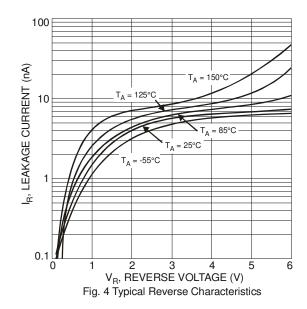
- 4. Measured from channel to pin 2; Non-repetitive current pulse per Fig. 2.
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- $\bf 6.$ Short duration pulse test used to minimize self-heating effect.



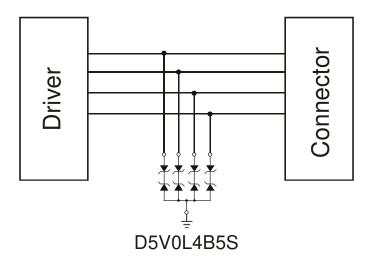






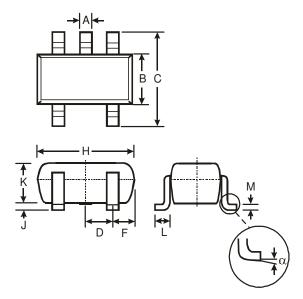


Typical Applications



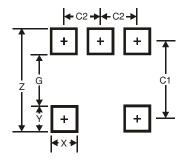


Package Outline Dimensions



SOT353					
Dim	Min	Max			
Α	0.10	0.30			
В	1.15	1.35			
С	2.00	2.20			
D	0.65 Typ				
F	0.40	0.45			
Н	1.80	2.20			
J	0	0.10			
K	0.90	1.00			
L	0.25	0.40			
М	0.10	0.22			
α	0°	8°			
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Υ	0.6
C1	1.9
C2	0.65



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